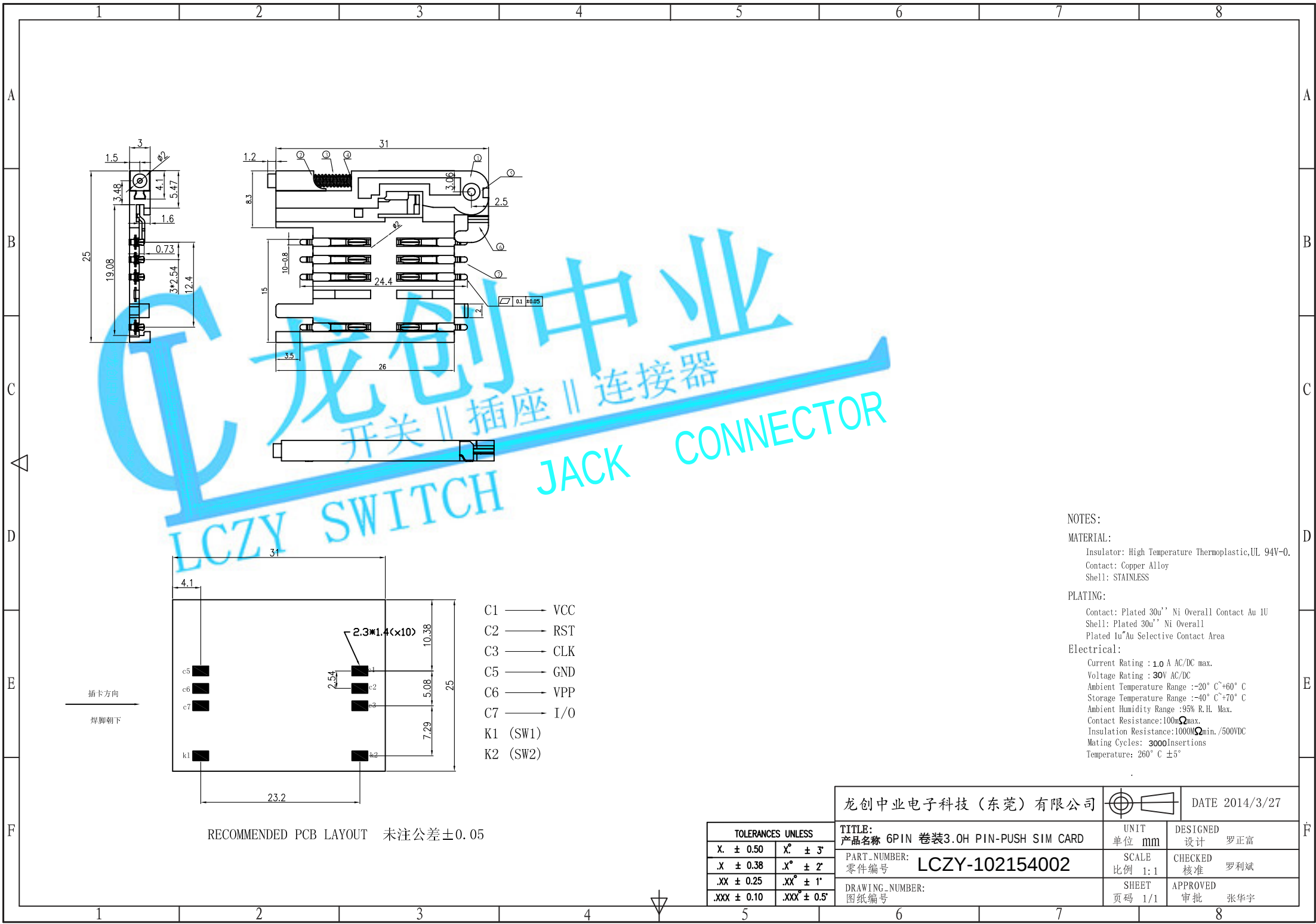




插卡方向

焊脚朝下

- C1 → VCC
- C2 → RST
- C3 → CLK
- C5 → GND
- C6 → VPP
- C7 → I/O
- K1 (SW1)
- K2 (SW2)

RECOMMENDED PCB LAYOUT 未注公差±0.05

NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic,UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

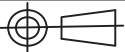
PLATING:

Contact: Plated 30u'' Ni Overall Contact Au 1U
Shell: Plated 30u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:

Current Rating : 1.0 A AC/DC max.
Voltage Rating : 30V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩmax.
Insulation Resistance:1000MΩmin./500VDC
Mating Cycles: 3000Insertions
Temperature: 260° C ±5°

龙创中业电子科技（东莞）有限公司



DATE 2014/3/27

TITLE:
产品名称 6PIN 卷装3.0H PIN-PUSH SIM CARD

UNIT
单位 mm

DESIGNED
设计 罗正富

PART NUMBER:
零件编号 LCZY-102154002

SCALE
比例 1:1

CHECKED
核准 罗利斌

DRAWING NUMBER:
图纸编号

SHEET
页码 1/1

APPROVED
审批 张华宇